

To:

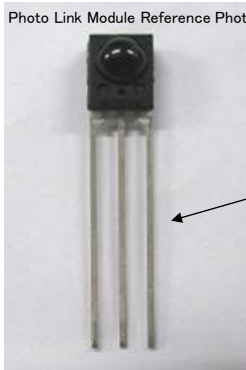


Issue No. OMPU14-028
 Issue Date: 2015/1/6
 Rohm Semiconductor
 Discreet Module Manufacture Headquarter
 Optical Module Manufacture Dep. QC Sector
 Person in Charge of QC 辻 章雄
 Responsible Staff 增川 芳昭



Process Change Notification

Please be advised that we will make the following changes to the terminal's plating specification.

| | |
|---------------|---|
| Target Mode | Photo Link Module : RPM6***、RPM7***Series |
| Content | <p>Photo Link Module Product Terminal Plating Specification Change Content</p> <p>Before change: Sn-Cu Plating specification After change: Sn Plating specification</p> <p>The mass production for the product after change will start from February, 2015 and production of the product before change is scheduled to terminate from March, 2015.</p> <div style="display: flex; align-items: center;"> <div style="text-align: center;"> <p>Photo Link Module Reference Photo</p>  </div> <div style="margin-left: 20px;"> <p><3 Terminal's Plating Specification></p> <p>Before change (current condition) : Sn-Cu plating specification ↓ After change: Sn plating specification</p> </div> </div> |
| Change Reason | <p><Change Reason></p> <p>Currently, the planting of the terminal part of this model is being done by outside maker and we have been notified that they will abolish Sn-Cu plating specification (and change to Sn plating specification), the current plating production will last until the end of March 2015. We have asked the maker to continue the production, however they couldn't fulfill our requirements, and we failed to find other suitable makers who can provide Sn-Cu plating. Therefore we concluded that the current Sn-Cu plating is no longer available.</p> <p>Given the circumstance, we decided to unify all the models of photo link module product to Sn plating.</p> <p>We will continue the current Sn-Cu plating until March 2015, however from May 2015, we will take the liberty of abolishing Sn-Cu plating specification and terminate the production. (the mass production for the new product starts from February 2015)</p> <p>We apologize for the inconvenience, please understand that from 2015/4/1 we will only produce Sn plating.</p> <p>This change will not affect the performance of the device characteristic.</p> |

Change Content Confirmation

Rohm Semiconductor Optical Module Manufacture Dep. QC Sector
 Application Name : Photo Link Module Product (RPM6***、RPM7***Series)'s terminal plating specification

Please confirm the above content.

| | |
|---|------------|
| Result: <ul style="list-style-type: none"> • Accept No problem • Accept under condition • Not accept | Condition: |
|---|------------|

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Company Name: _____